

C1206C333F5GECAUT07210

ESD SMD Auto COG, Ceramic, $0.033~{\rm uF},$ 1%, 50 VDC, COG, SMD, MLCC, Temperature Stable, Electro Static Discharge, Automotive Grade, 1206, 1.5 mm



Click here for the 3D model.

General Information	
Series	ESD SMD Auto COG
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Electro Static Discharge, Automotive Grade
Features	Temperature Stable, Automotive Grade
RoHS	Yes
Termination	Tin
Marking	No
Qualifications	AEC-Q200
AEC-Q200	Yes
Typical Component Weight	30 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1206
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
Т	1.2mm +/-0.15mm
S	1.5mm MIN
В	0.5mm +/-0.25mm

Packaging Specifications Packaging

Pa

Packaging	T&R, 330mm, Plastic Tape
ackaging Quantity	10000

Specifications	
Capacitance	0.033 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	1%
Voltage DC	50 VDC
ESD Level per AEC-Q200	25,000 V ESD Level
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	30.303 GOhms

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